DATA SHEET							
SUNGMUN CODE : STP-1250S SERIES							
DESCRIPTION : TACT SWITCH							
SUNGMUN ELECTRONICS CO., LTD.							
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							0 <u>8.0 ±0.2</u>	t0.3 3.5 5.0 ±0.2	3.0			₽ O ±0.2	
SUNGMUN ELE		W.J.LEE J.P.R	NO. DESC	- 01			2-1.0		 ປັ	9.2		P.B.C LAND PATTERN	MRK. DATE
)TRONICS CO.,LTD SIZE A4	mm 4:1		IPTION MATERIAL	1	STP-1250SW	STP-1250S	5. MODEL OPI	1. RATING : DC 12V 50 2. TRAVEL : 0.25±0.1m 3. CONTACT RESISTAN 4. BOUNCE : 10m SEC	SPECIFICATION	<u>+</u>			REVISION
NO. STP-1250S	MODEL STP-1250S	TITLE TACT SWI	COLOR/FINISH	I	250±50gf	180±50gf	ERATING FORCE	שמא אמא אמא:			RCUIT DIAGRA		
0-S-01 1/1	X SHEET	TCH	Q,TY VENDOR	-	30,000 CYCLE	50,000 CYCLE	LIFE CYCLES				∑ ¶¥		SIGN

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SME 151028



### 1. Description:

This specification covers the requirements for single key switches which have no key top(Tact switches mechanical contact).

- 1-1 Operating Temperature Range : -40°C ~ +70°C (normal humidity, normal press)
- 1-2 Storage Temperature Range : -40°C ~ +80°C
- 1-3 Test Conditions :

Tests and measurements shall be made in the following standard conditions unless otherwise specified :

Normal temperature (temperature 5 to 35°C)

Normal humidity (relative humidity 45 to 85%)

Normal pressure (pressure 860 to 1,060 mbars)

In case any question arises from the judgment made, tests shall be conducted in the following conditions:

Temperature	(20±2°C)
Relative humidity	(65±5%)
Pressure	(860 to 1,060 mbars)

#### 2. Rating:

2-1 Maximum Rating : 50 mA, DC 12V

3. Type of Actuation : Push-ON type

4. Contact Arrangement : 1 poles 1 throws (SPST)



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ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
5-1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.
5-2	Contact Resistance	<ol> <li>Applying static load twice the actuating force to the center of the stem.</li> <li>Measurements shall be made with a 1kHz shall current contact resistance meter.</li> </ol>	100mΩ max.
5-3	Insulation Resistance	100V DC insulation resistance meter	100 MΩ min.
5-4	Dielectric withstanding Voltage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame for 1 minute.	There shall be no breakdown or flashover.
5-5	BOUNCE	Lightly striking the center of the stem at a rate encountered in normal use(3 ~4 operations per sec), Bounce shall be tested when "ON" and "OFF".	10ms max.



ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
6-1	Operation Force	Push by recommended operating condition. Force Push force Return force Stroke	See outside drawing
6-2	Travel	Push by recommended operating condition. F = (Operation force) ×2 F Travel	0.25±0.1 mm
6-3	Stem Strength	The maximum force to withstand a pull applied opposite to the direction of stem operation shall be measured.	0.5 kgf•cm min
6-4	Stop Strength	A static load of 3 kgf shall be applied in the direction of stem operation for a period of 60 seconds.	There shall be no sigh of damage mechanically and electrically.
6-5	Operation Life	Measurements shall be made following the test set forth below: 1) 50mA, 12V DC resistive load 2) Rate of operation: 2~3 cycles/ sec 3) Step of operation: See outside drawing	<ol> <li>As shown in item 5-3, 5-4, 6-2</li> <li>Contact Resistance: 200mΩ max</li> <li>Bounce : 20m sec max</li> <li>Actuating force : ±30% initial force</li> </ol>



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7. Environmental Characteristics				
ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS	
7-1	Moisture Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements. Are made : 1) Temperature : 60±2°C 2) Relative humidity : 90 to 95% 3) Time : 96 hours Water drops shall be removed.	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max	
7-2	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: -40℃±2℃ 2)Time: 96 hours Water drops shall be removed.	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max	
7-3	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 80°C±2°C 2)Time: 96 hours	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max	
7-4	Impact Shock Resistance	Measurements shall be made following the test set forth below : 1) Acceleration : 80G 2) Cycles of test : 3 cycles each in 6 directions, for a total of 18 cycles.	Item 5 Item 6-1, 6-2	



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ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
7-5	Change of Temperature	Following 5 cycles of high temperature test. The sample shall be placed in normal temperature and humidity conditions for one hour before measurements are made. During this test, water drops shall be removed. $60^{\circ}C$	1)As shown in item 5-3, 5-4, 5-5, 6-1, 6-2 2)Contact Resistance: 200mΩ max
7-6	Vibration Resistance	<ul> <li>Measurements shall be made following the test set forth below :</li> <li>1) Range of oscillation : 10 to 55Hz</li> <li>2) Amplitude, peak to peak : 1.5mm</li> <li>3) Cycle of sweep : 10-55-10Hz in a minute.</li> <li>4) Mode of sweep : Logarithmically seep or uniform sweep.</li> <li>5) Direction of oscillation : Three mutually perpendicular direction, including the direction of stem travel.</li> <li>6) 2 hours each for a total of 6 hours.</li> </ul>	Item 5 Item 6-1, 6-2

### 8. This item is "RoHS" Compliant



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#### 9. Reflow Soldering Conditions:

9-1 Preheat : Temperature on the copper foil surface should reach 180°C, 2±0.3 minutes after the P.W.B entered into the soldering equipment.

9-2 Soldering heat : Temperature on the copper foil surface should reach the peak temperature of 260°C within 40 seconds after the P.W.B entered into soldering heat zone.



#### **Temperature Profile**